

Section 1 #3

**PATENT APPLICATION**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Toshinori NAKAYAMA

Application No.: 09/626,146

Filed: July 26, 2000



ATTN: Application Branch

Docket No.: 106364

For: SUBSTRATE FOR SEMICONDUCTOR DEVICE, SEMICONDUCTOR CHIP MOUNTING SUBSTRATE, SEMICONDUCTOR DEVICE AND METHOD OF FABRICATION THEREOF, AND CIRCUIT BOARD, TOGETHER WITH ELECTRONIC EQUIPMENT

**NOTICE TO FILE MISSING PARTS STATUS REQUEST**

Director of the U.S. Patent and Trademark Office  
Washington, D.C. 20231

Sir:

The above-captioned patent application was filed on July 26, 2000. A copy of the postcard receipt is attached hereto.

The Notice to File Missing Parts has not yet been received. It is respectfully requested that the Notice to File Missing Parts be immediately forwarded to the attorneys of record at the address set forth below.

If there are any questions regarding this matter, please contact the undersigned at the telephone number set forth below.

Respectfully submitted,

  
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Date: October 26, 2000

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**RECEIPT FOR FILING OF PAPERS**

**The following papers have been filed:**

Trans. Ltr. & Ck 110592 \$912, 37 pp. spec., 28 claims, Abst., 8 sheets dwgs (1-14), Claim for Priority & cert. copies of JP 11-213184 07/28/1999, JP 2000-173294 06/09/2000

**Name of Applicant:** Toshinori NAKAYAMA

**Serial No.:** New U.S. Patent Application

**Atty. File No.:** 106364

**Title (New Cases):** SUBSTRATE FOR SEMICONDUCTOR DEVICE,  
SEMICONDUCTOR CHIP MOUNTING SUBSTRATE,  
SEMICONDUCTOR DEVICE AND METHOD OF FABRICATION  
THEREOF, AND CIRCUIT BOARD, TOGETHER WITH  
ELECTRONIC EQUIPMENT

**Sender's Initials:** JAO/cmm

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